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1. Name of conveying party(ies):

Bour-Yi Sze, Chih-Long Ho and
Nean-Chu Cheng

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Name: VIA Technologies, Inc.

Internal Address: _____

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:



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Change of Name



Other _____

Street Address: 8F, 535 Chung-Cheng Road

Hsin-Tien

City: Taipei, Taiwan State: _____ Zip: ROC 231

Execution Date: 01/17/2005

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4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 01/31/05

A. Patent Application No.(s) _____

B. Patent No.(s) _____

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Howard Chen

Internal Address: _____

Preston Gates & Ellis LLP

Street Address: 55 Second Street

Suite 1700

City: San Francisco State: CA Zip: 94105

6. Total number of applications and patents involved: 1 ☐

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ASSIGNMENT AND AGREEMENT

For value received, I/we, **Bour-Yi Sze, Chih-Long Ho, and Nean-Chu Cheng**, hereby sell, assign and transfer to **VIA Technologies, Inc. of Taiwan, R.O.C.** with its principal place of business located at 8F, 535 Chung-Cheng Road, Hsin-Tien, Taipei 231, Taiwan R.O.C., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to **HIGHLY-LINEAR SIGNAL-MODULATED VOLTAGE CONTROLLED OSCILLATOR** described in an application for Letters Patent of the United States executed on even date herewith, and all the rights and privileges in said application and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to VIA Technologies, Inc. of Taiwan, R.O.C., the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I/We authorize VIA Technologies, Inc. of Taiwan, R.O.C., to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I/We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of VIA Technologies, Inc. of Taiwan, R.O.C., to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I/We request that any and all patents for said inventions be issued to VIA Technologies, Inc. of Taiwan, R.O.C., Inc., in the United States and in all countries foreign to the United States, or to such nominees as VIA Technologies, Inc. of Taiwan, R.O.C., may designate.

I/We agree that, when requested, I/we shall, without charge to VIA Technologies, Inc. of Taiwan, R.O.C., but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

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